



MURS320

3.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 75A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)

Mechanical Data

- Case: SMC
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.21 grams (approximate)





Top View

Bottom View

Ordering Information (Note 3)

Part Number	Case	Packaging
MURS320-13-F	SMC	3000/Tape & Reel, 13-inch

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



U3D = Product type marking code

Oii = Manufacturers' code marking

YWW = Date code marking

Y = Last digit of year (ex: 6 for 2006)

WW = Week code (01 to 53)



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 4)	V _{RRM} V _{RWM} V _R	200	V
RMS Reverse Voltage	V _{R(RMS)}	140	V
Average Rectified Output Current @ T _L = 140°C	Ю	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	75	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Total Capacitance (Note 5)	C _T	45	pF
Typical Thermal Resistance, Junction to Lead (Note 6)	$R_{\theta JL}$	11	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +175	°C

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Forward Voltage	@ I _F = 3.0A, T _J = 25°C @ I _F = 3.0A, T _J = 150°C	V_{FM}	0.875 0.71	\
Peak Reverse Current at Rated DC Blocking Voltage (Note 4)	@ $T_J = 25^{\circ}C$ @ $T_J = 150^{\circ}C$	IDM	5.0 100	μΑ
Reverse Recovery Time (Note 7)		t _{rr}	25	ns
Maximum Forward Recovery Time (Note	8)	t _{fr}	25	ns

Notes:

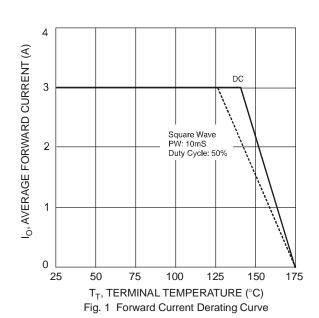
- 4. Short duration pulse test used to minimize self-heating effect.
- 4. Short duriation pulse test used to fill inflig effect.

 5. Measured at 1.0MHz and applied reverse voltage of 0V DC.

 6. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.

 7. Measured with $I_F = 0.5A$, $I_R = 1.0A$, $I_{tr} = 0.25A$. See Figure 5.

 8. Measured with $I_F = 1.0A$, $di/dt = 100A/\mu S$, Recovery to 1.0V.



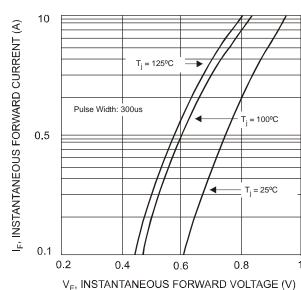
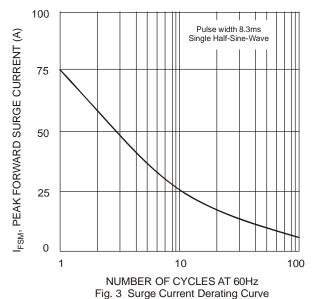
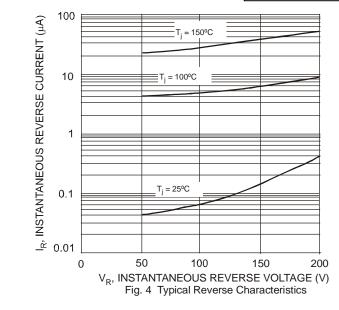
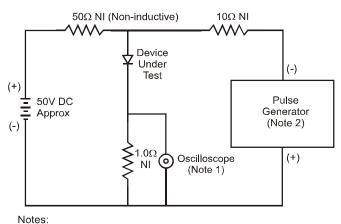


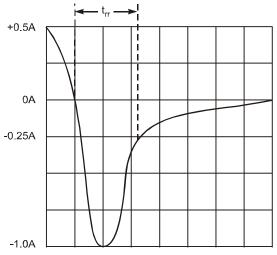
Fig. 2 Typical Forward Characteristics







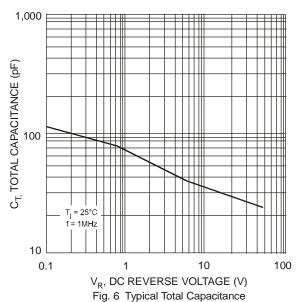




- 1. Rise Time = 7.0ns max. Input Impedance = $1.0M\Omega$, 22pF.
- 2. Rise Time = 10ns max. Input Impedance = 50Ω .

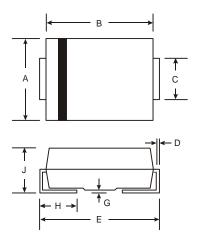
Set time base for 50/100 ns/cm





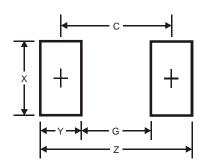


Package Outline Dimensions



SMC			
Dim	Min	Max	
Α	5.59	6.22	
В	6.60	7.11	
C	2.75	3.18	
D	0.15	0.31	
Е	7.75	8.13	
G	0.10	0.20	
Η	0.76	1.52	
7	2.00	2.50	
All Dimensions in mm			

Suggested Pad Layout



Dimensions	Value (in mm)
Z	9.3
G	4.4
Х	3.3
Y	2.5
С	6.8



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